



# **TH 212 Non Silicone Gap Filler**

### **Description**

TH212 is a yellowish, highly filled non-silicone system suitable for thermal dissipation of electronic devices. It has stable pot life and long shelf life even at room temperature of 25°C.

### **Applications**

Heat dissipation from electronic components.

#### **Guidelines for Use**

- 1. Wear rubber gloves when handling the product.
- 2. Pick up the productfrom the container using hand.
- 3. Place the product onto the required electronic part and circuit.
- 4. No heating nor curing is required.
- 5. The product can be applied and removed easily. Care must be taken during installation to avoid tearing.

#### **Properties**

Property	Test Method	Unit	Typical Value
Chemical type	-	-	Non-silicone
Appearance	Pen 10	-	Yellowish White
Shelf life, 25°C	Pen 26	Month	12
Operating temperature	Pen 92	°C	-40 to 125
Tensile strength	PEN 92	kg/cm <sup>2</sup>	4.0 – 6.0
Elongation	PEN 92	%	> 80
Hardness	Pen 29	Shore 00	65
Viscosity	Pen 44	сР	Pad
Thermal conductivity	ASTM D5470	Wm <sup>-1</sup> K <sup>-1</sup>	2.4
Density	Pen 14	g/cm <sup>3</sup>	1.6

# **Storage**

Store this non-silicone gap filler in an air tight container in a cool (20°C to 30°C) and dark placeto prolong shelf life. Avoid contact with moisture.

#### **Packaging& Dimension**

- Sheet form
- Will provide customized dimension if required

# **Environment, Health & Safety**

This product is RoHS compliant. It does not contain any known carcinogenic, mutagenic or teratogenic components.

#### **Contact Information**

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